

TYPE 2N3966

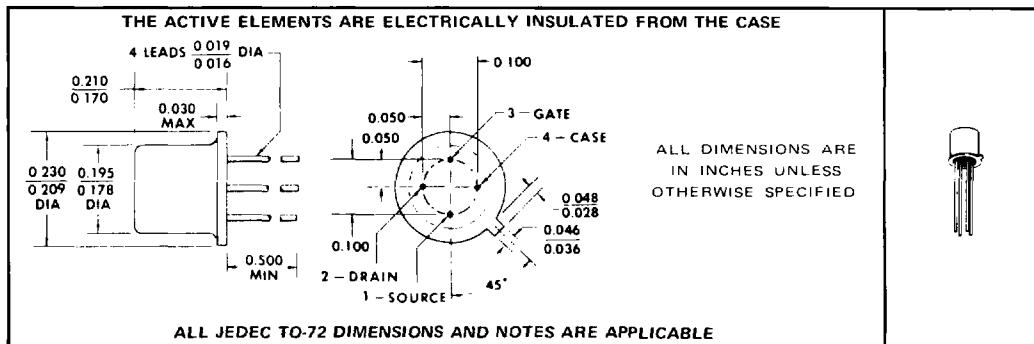
N-CHANNEL SILICON JUNCTION FIELD-EFFECT TRANSISTOR

BULLETIN NO. DL-S 7011356, AUGUST 1970

FOR HIGH-SPEED COMMUTATOR AND CHOPPER APPLICATIONS

- Low $r_{ds(on)}$ 220 Ω Max
- Low $I_D(\text{off})$ 1 nA Max
- Low C_{rss} 1.5 pF Max

*mechanical data



*absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

Drain-Gate Voltage	30 V
Drain-Source Voltage	30 V
Reverse Gate-Source Voltage	-30 V
Continuous Forward Gate Current	10 mA
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 1)	300 mW
Storage Temperature Range	-55°C to 200°C
Lead Temperature 1/16 Inch from Case for 10 Seconds	300°C

*electrical characteristics at 25°C free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	MIN	MAX	UNIT
$V_{(BR)GSS}$	Gate-Source Breakdown Voltage $I_G = -1 \mu\text{A}, V_{DS} = 0$	-30		V
I_{GSS}	Gate Reverse Current $V_{GS} = -20 \text{ V}, V_{DS} = 0$	-0.1	nA	
I_{DGO}	$V_{DG} = 20 \text{ V}, I_S = 0$	0.1	nA	
	$V_{DG} = 20 \text{ V}, I_S = 0, T_A = 150^\circ\text{C}$	0.2	μA	
$I_{D(\text{off})}$	$V_{DS} = 10 \text{ V}, V_{GS} = -7 \text{ V}$	1	nA	
	$V_{DS} = 10 \text{ V}, V_{GS} = -7 \text{ V}, T_A = 150^\circ\text{C}$	2	μA	
$V_{GS(\text{off})}$	Gate-Source Voltage $V_{DS} = 10 \text{ V}, I_D = 10 \text{ nA}$	-4	-6	V
I_{DSS}	Zero-Gate-Voltage Drain Current $V_{DS} = 20 \text{ V}, V_{GS} = 0$	2	mA	
$V_{DS(\text{on})}$	Drain-Source On-State Voltage $V_{GS} = 0, I_D = 1 \text{ mA}$	0.25	V	
$r_{ds(\text{on})}$	Small-Signal Drain-Source On-State Resistance $V_{GS} = 0, I_D = 0, f = 1 \text{ kHz}$	220	Ω	
C_{iss}	Common-Source Short-Circuit Input Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	6	pF	
C_{rss}	Common-Source Short-Circuit Reverse Transfer Capacitance $V_{DS} = 0, V_{GS} = -7 \text{ V}, f = 1 \text{ MHz}$	1.5	pF	

NOTE 1. Derate linearly to 200°C free air temperature at the rate of 1.71 mW°C.

*JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.

†The fourth lead (case) is connected to the source for all measurements.

USES CHIP JN51

TYPE 2N3966

N-CHANNEL SILICON JUNCTION FIELD-EFFECT TRANSISTOR

*switching characteristics at 25°C free-air temperature

PARAMETER	TEST CONDITIONS [†]	MAX	UNIT
$t_{d(on)}$ Turn-On Delay Time	$V_{DD} = 1.5 \text{ V}$, $I_D(\text{on}) \approx 1 \text{ mA}$,	20	ns
t_r Rise Time	$V_{GS(\text{on})} = 0$, $V_{GS(\text{off})} = -6 \text{ V}$,	100	ns
t_{off} Turn-Off Time	See Figure 1	100	ns

[†]The fourth lead (case) is connected to the source for all measurements.

*PARAMETER MEASUREMENT INFORMATION

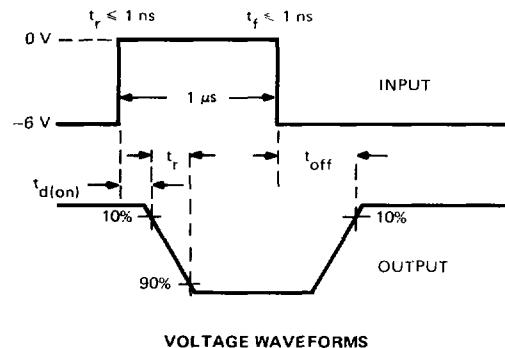
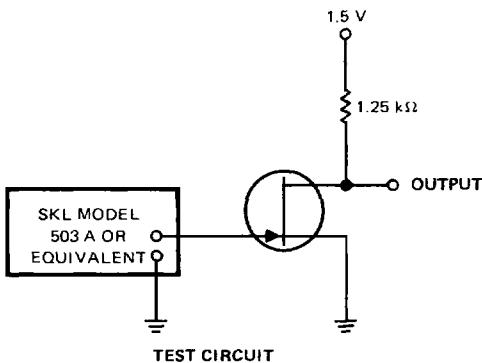


FIGURE 1—SWITCHING TIMES

NOTES: A. The input waveforms are supplied by a generator with the following characteristics: $Z_{out} = 50 \Omega$, duty cycle $\leq 50\%$.
 B. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 10 \text{ ns}$, $R_{in} \geq 5 \text{ M}\Omega$, $C_{in} \leq 10 \text{ pF}$.

*JEDEC registered data